



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	6	V
Power dissipation		P_{diss}	70	mW
Forward current		I_F	60	mA
OUTPUT				
Collector emitter voltage		V_{CEO}	55	V
Emitter collector voltage		V_{ECO}	7	V
Collector current		I_C	50	mA
	$t_p \leq 1\text{ ms}$	I_C	100	mA
Power dissipation		P_{diss}	150	mW
COUPLER				
Storage temperature range		T_{stg}	-55 to +150	$^{\circ}\text{C}$
Ambient temperature range		T_{amb}	-55 to +100	$^{\circ}\text{C}$
Junction temperature		T_j	125	$^{\circ}\text{C}$
Soldering temperature	max. 10 s, dip soldering distance to seating plane $\geq 1.5\text{ mm}$	T_{sld}	260	$^{\circ}\text{C}$

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability

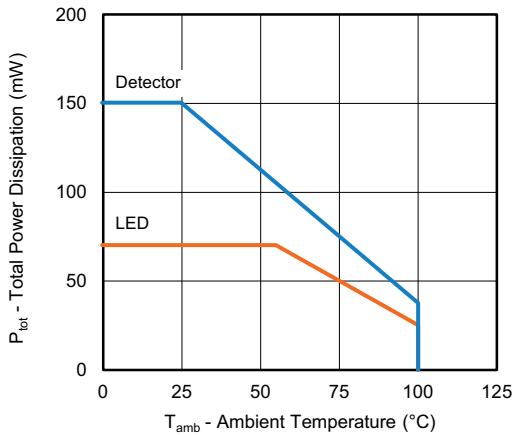


Fig. 1 - Permissible Power Dissipation vs. Ambient Temperature



ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	$I_F = 5\text{ mA}$		V_F	-	1.1	1.5	V
Reverse current	$V_R = 6\text{ V}$		I_R	-	0.01	10	μA
Capacitance	$V_R = 0\text{ V}, f = 1\text{ MHz}$		C_O	-	25	-	pF
Thermal resistance			R_{thja}	-	1070	-	K/W
OUTPUT							
Collector emitter leakage current	$V_{CE} = 10\text{ V}$		I_{CEO}	-	10	200	nA
Collector emitter capacitance	$V_{CE} = 5\text{ V}, f = 1\text{ MHz}$		C_{CE}	-	7	-	pF
Thermal resistance			R_{thja}	-	500	-	K/W
COUPLER							
Collector emitter saturation voltage	$I_C = 0.32\text{ mA}, I_F = 1\text{ mA}$	SFH618A-2	V_{CEsat}	-	0.25	0.4	V
		SFH6186-2	V_{CEsat}	-	0.25	0.4	V
	$I_C = 0.5\text{ mA}, I_F = 1\text{ mA}$	SFH618A-3	V_{CEsat}	-	0.25	0.4	V
		SFH6186-3	V_{CEsat}	-	0.25	0.4	V
	$I_C = 0.8\text{ mA}, I_F = 1\text{ mA}$	SFH618A-4	V_{CEsat}	-	0.25	0.4	V
		SFH6186-4	V_{CEsat}	-	0.25	0.4	V
	$I_C = 1.25\text{ mA}, I_F = 1\text{ mA}$	SFH618A-5	V_{CEsat}	-	0.25	0.4	V
		SFH6186-5	V_{CEsat}	-	0.25	0.4	V
Coupling capacitance			C_C	-	0.25	-	pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements

CURRENT TRANSFER RATIO ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
I_C/I_F	$I_F = 1\text{ mA}, V_{CE} = 0.5\text{ V}$	SFH618A-2	CTR	63	-	125	%
		SFH6186-2	CTR	63	-	125	%
	$I_F = 0.5\text{ mA}, V_{CE} = 1.5\text{ V}$	SFH618A-2	CTR	32	75	-	%
		SFH6186-2	CTR	32	75	-	%
	$I_F = 1\text{ mA}, V_{CE} = 0.5\text{ V}$	SFH618A-3	CTR	100	-	200	%
		SFH6186-3	CTR	100	-	200	%
	$I_F = 0.5\text{ mA}, V_{CE} = 1.5\text{ V}$	SFH618A-3	CTR	50	120	-	%
		SFH6186-3	CTR	50	120	-	%
	$I_F = 1\text{ mA}, V_{CE} = 0.5\text{ V}$	SFH618A-4	CTR	160	-	320	%
		SFH6186-4	CTR	160	-	320	%
	$I_F = 0.5\text{ mA}, V_{CE} = 1.5\text{ V}$	SFH618A-4	CTR	80	200	-	%
		SFH6186-4	CTR	80	200	-	%
	$I_F = 1\text{ mA}, V_{CE} = 0.5\text{ V}$	SFH618A-5	CTR	250	-	500	%
		SFH6186-5	CTR	250	-	500	%
	$I_F = 0.5\text{ mA}, V_{CE} = 1.5\text{ V}$	SFH618A-5	CTR	125	300	-	%
		SFH6186-5	CTR	125	300	-	%

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Turn on time	$V_{CC} = 5\text{ V}, I_C = 2\text{ mA}, R_L = 100\text{ }\Omega$	t_{on}	-	6	-	μs	
Rise time	$V_{CC} = 5\text{ V}, I_C = 2\text{ mA}, R_L = 100\text{ }\Omega$	t_r	-	3.5	-	μs	
Turn off time	$V_{CC} = 5\text{ V}, I_C = 2\text{ mA}, R_L = 100\text{ }\Omega$	t_{off}	-	5.5	-	μs	
Fall time	$V_{CC} = 5\text{ V}, I_C = 2\text{ mA}, R_L = 100\text{ }\Omega$	t_f	-	5	-	μs	

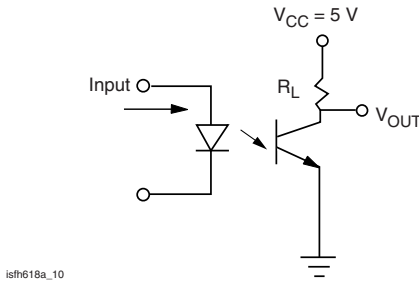


Fig. 2 - Test Circuit

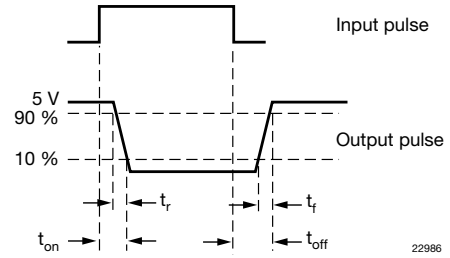


Fig. 3 - Parameter and Limit Definition

SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 115 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, t = 1 min	V_{ISO}	4470	V_{RMS}
Tested withstanding isolation voltage	According to UL1577, t = 1 s	V_{ISO}	5300	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	8000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	890	V_{peak}
Isolation resistance	$T_{amb} = 25\text{ }^{\circ}\text{C}$, $V_{IO} = 500\text{ V}$	R_{IO}	$\geq 10^{12}$	Ω
	$T_{amb} = 100\text{ }^{\circ}\text{C}$, $V_{IO} = 500\text{ V}$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	700	mW
Input safety current		I_{SI}	400	mA
Input safety temperature		T_S	175	$^{\circ}\text{C}$
Creepage distance	DIP-4		≥ 7	mm
Clearance distance			≥ 7	mm
Creepage distance	DIP-4, 400 mil, option 6		≥ 8	mm
Clearance distance			≥ 8	mm
Creepage distance	SMD-4, option 7 and option 9		≥ 7	mm
Clearance distance			≥ 7	mm
Insulation thickness		DTI	≥ 0.4	mm

Note

- As per DIN EN 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

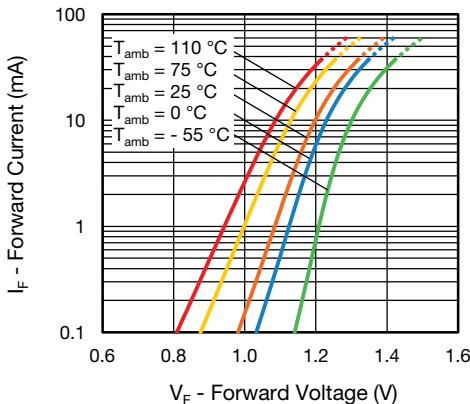


Fig. 4 - Forward Voltage vs. Forward Current

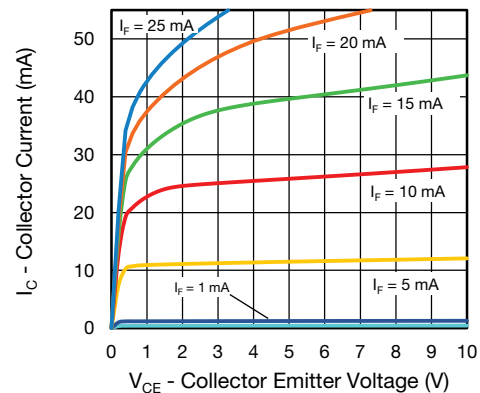


Fig. 5 - Collector Current vs. Collector Emitter Voltage

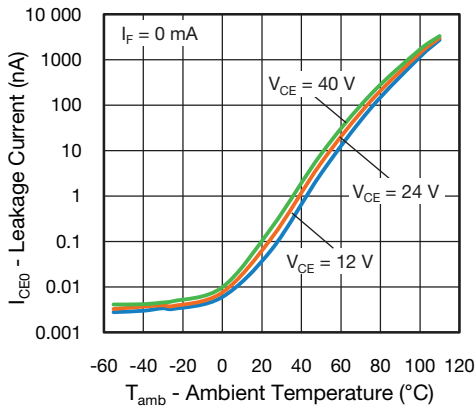


Fig. 6 - Collector Emitter Current vs. Ambient Temperature

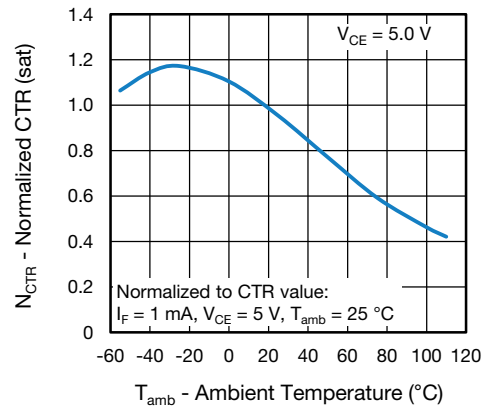


Fig. 9 - Normalized Current Transfer Ratio vs. Ambient Temperature (sat.)

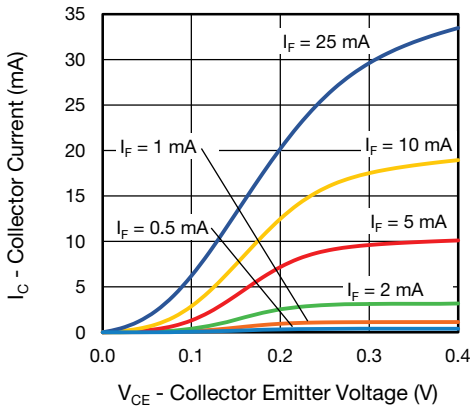


Fig. 7 - Collector Current vs. Collector Emitter Voltage

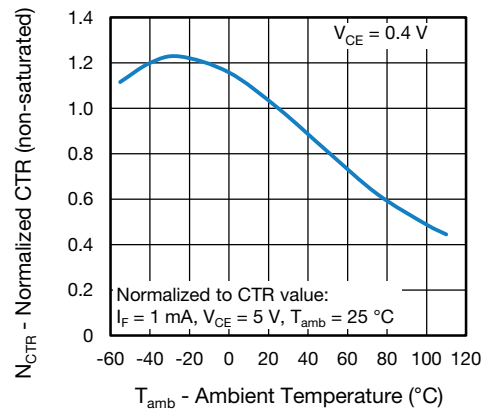


Fig. 10 - Normalized Current Transfer Ratio vs. Ambient Temperature (non-sat.)

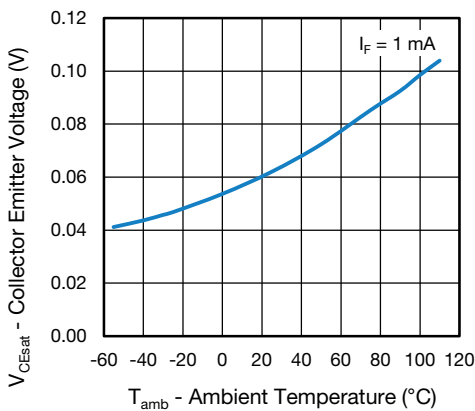


Fig. 8 - Collector Emitter Voltage vs. Ambient Temperature

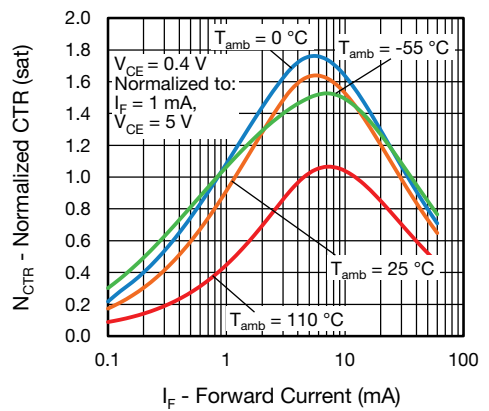


Fig. 11 - Current Transfer Ratio vs. Forward Current (sat.)

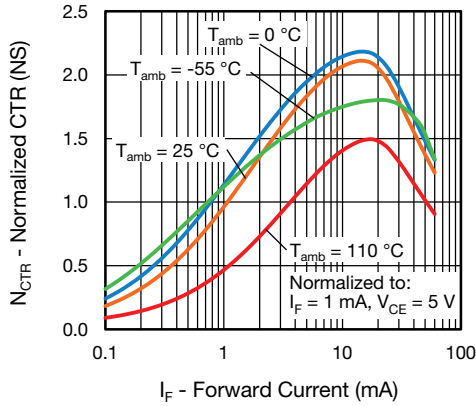


Fig. 12 - Current Transfer Ratio vs. Forward Current (non-sat.)

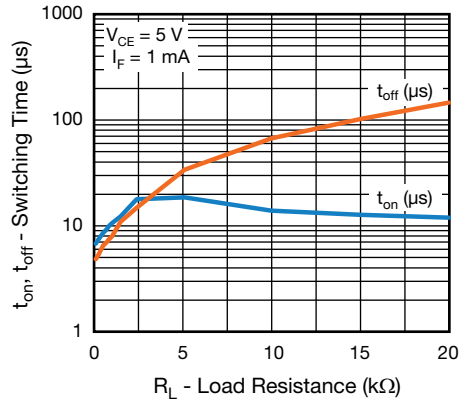


Fig. 15 - Switching Time vs. Load Resistance

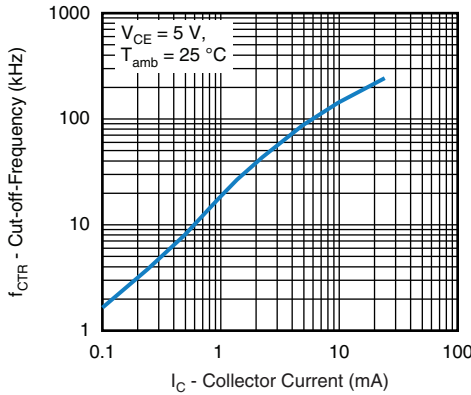


Fig. 13 - Cut-Off Frequency vs. Collector Current

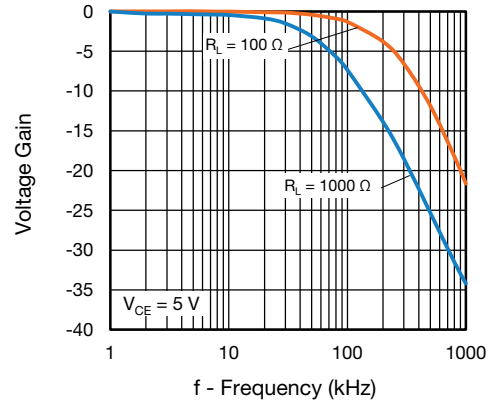


Fig. 16 - Voltage Gain vs. Frequency

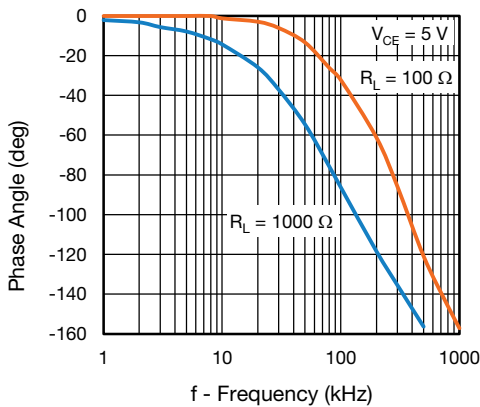
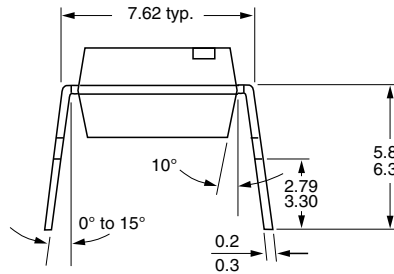
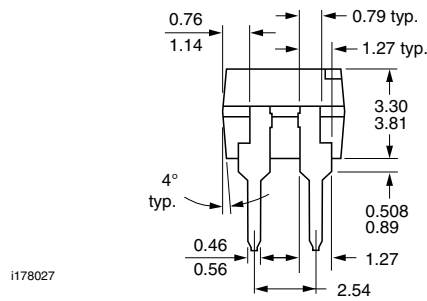
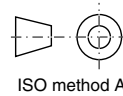
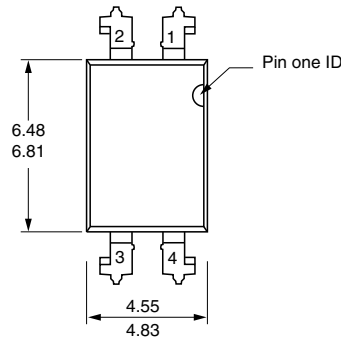


Fig. 14 - Phase Angle vs. Frequency

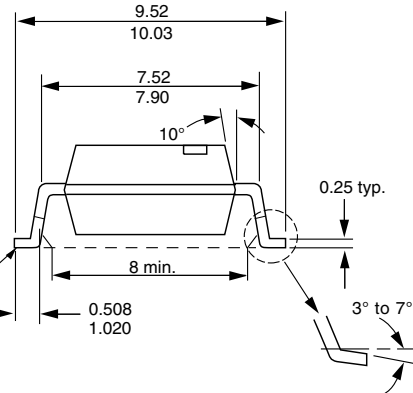
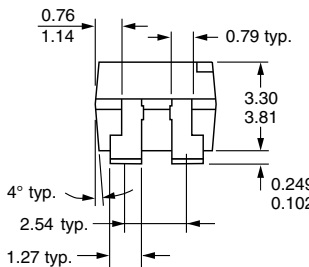
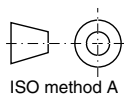
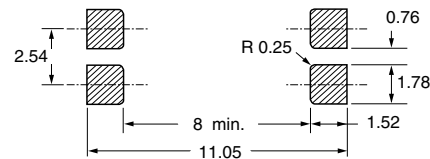
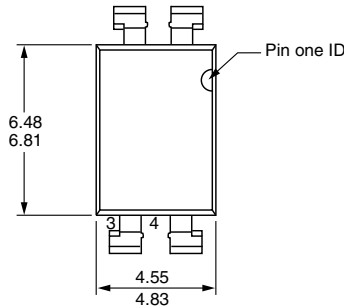


PACKAGE DIMENSIONS (in millimeters)



i178027

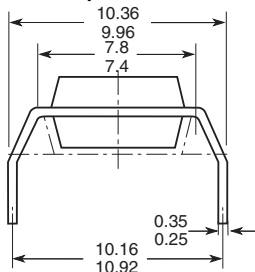
SMD



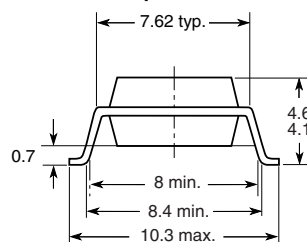
Lead coplanarity 0.004 max.

i178029

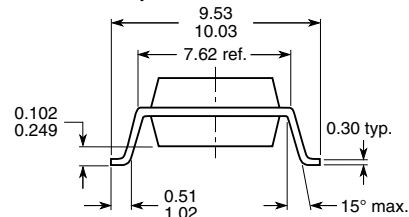
Option 6



Option 7

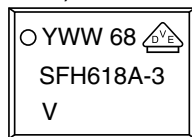


Option 9 or SFH6186



18450-11

PACKAGE MARKING (example of SFH618A-3X001)



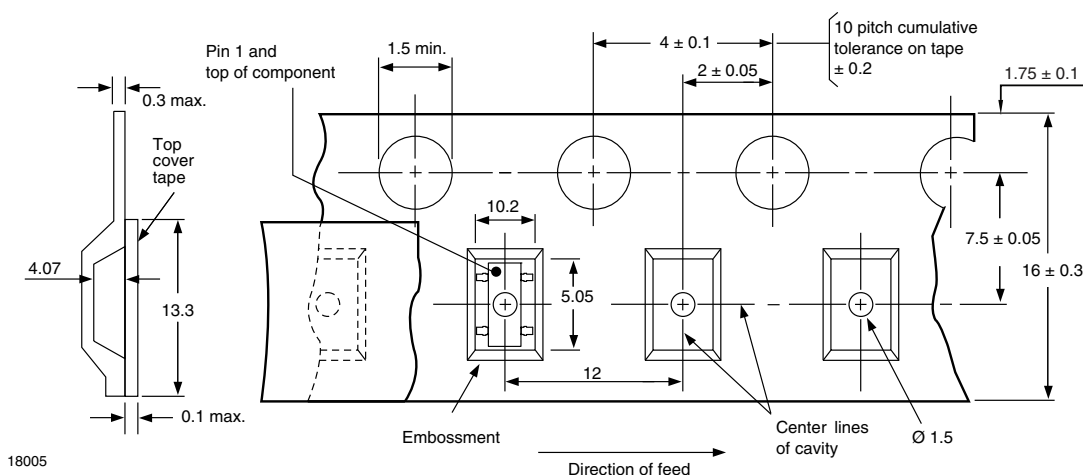
Notes

- VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking

TAPE AND REEL PACKAGING (in millimeters)

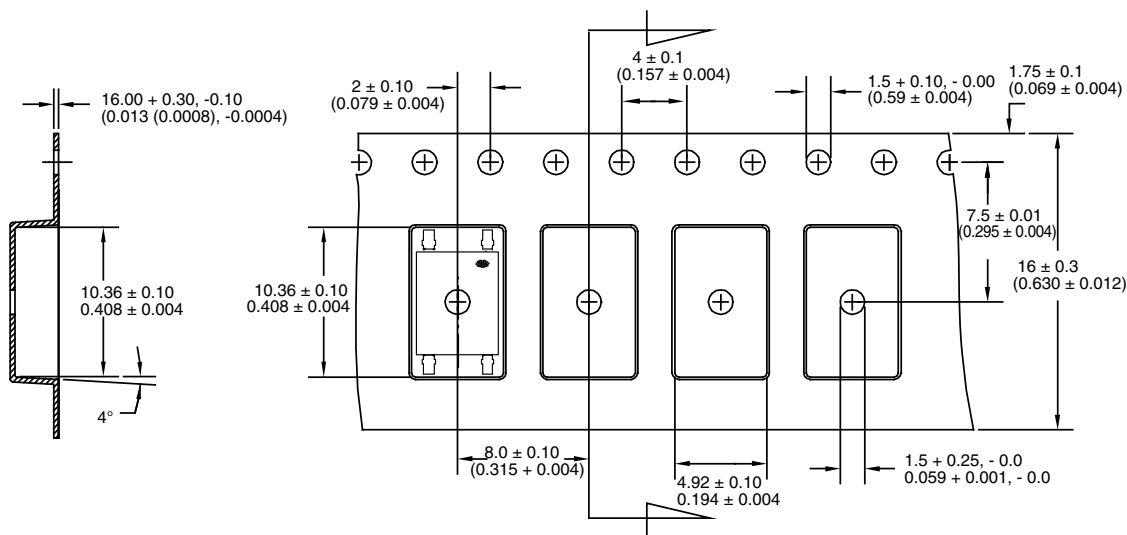
The tape is 16 mm and is wound on a 33 cm reel. There are 1000 parts per reel. Taped and reeled 4 pin optocouplers conform to EIA-481-2 and IEC60286-3.

SMD-4 ("T")



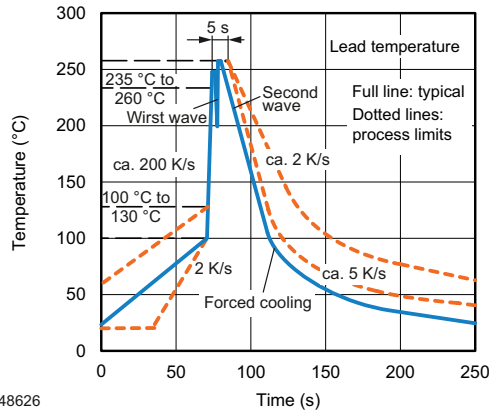
18005

SMD-4, 90° Rotation ("T1")



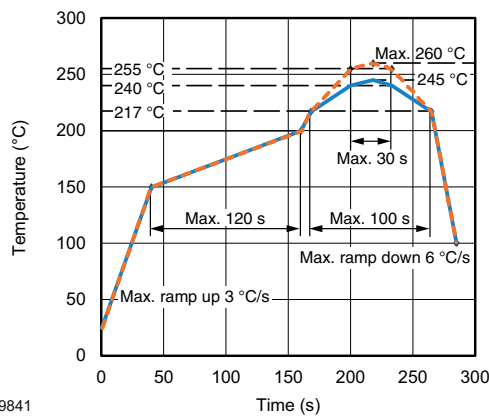
18401

SOLDER PROFILES



948626

Fig. 17 - Recommended Wave Soldering Double Wave Profile for DIP Devices



19841

Fig. 18 - Recommended Lead (Pb)-free Reflow Solder Profile for SMD Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ }^{\circ}\text{C}$, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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